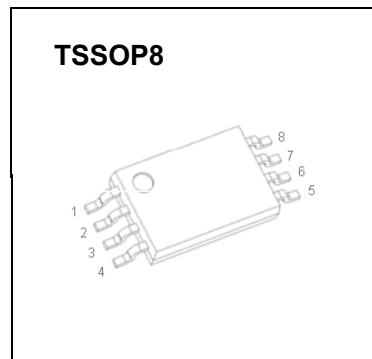




TSSOP8 Plastic-Encapsulate MOSFETS

CJS2010 Dual N-channel MOSFET

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
20V	9.5mΩ@4.5V	10A
	10mΩ@4V	
	10.5mΩ@3.5V	
	11.5mΩ@3.1V	
	13mΩ@2.5V	



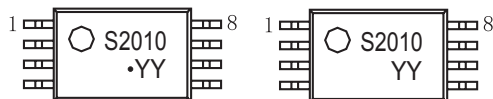
FEATURE

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$
- Low Gate Charge
- High Power and Current Handling Capability
- Surface Mount Package

APPLICATION

- Battery Protection
- Load Switch
- Power Management

MARKING

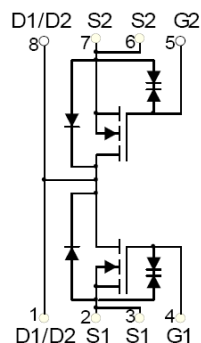


S2010= Device code , YY=Date Code

Solid dot=Pin1 indicator

Solid dot = Green molding compound device,
if none,the normal device.

Equivalent Circuit



MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 10	V
Continuous Drain Current	I_D	10	A
Pulsed Drain Current (note 1)	I_{DM}	36	A
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	125	$^{\circ}\text{C/W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55~+150	$^{\circ}\text{C}$
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	T_L	260	$^{\circ}\text{C}$

MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25^{\circ}\text{C}$ unless otherwise specified

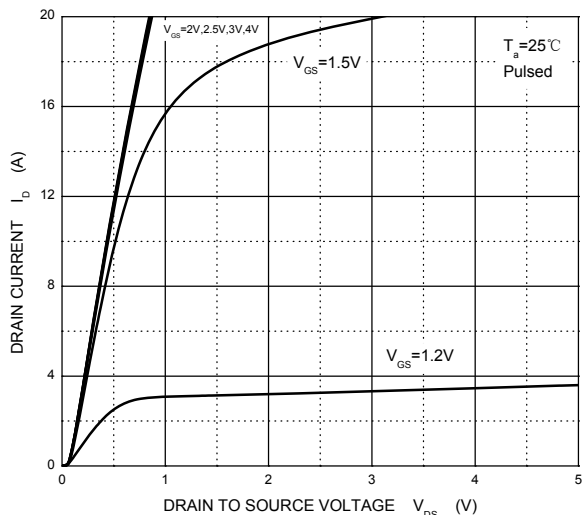
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	20			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V,V _{GS} = 0V			1	uA
Gate-body leakage current	I _{GSS}	V _{GS} =±10V, V _{DS} = 0V			±10	uA
Gate threshold voltage (note 3)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.3		1	V
Drain-source on-resistance(note 3)	R _{DS(on)}	V _{GS} =4.5V, I _D =10A	5.5		9.5	mΩ
		V _{GS} =4V, I _D =10A	5.8		10	mΩ
		V _{GS} =3.5V, I _D =9A	6		10.5	mΩ
		V _{GS} =3.1V, I _D =9A	6.3		11.5	mΩ
		V _{GS} =2.5V, I _D =8A	6.8		13	mΩ
Forward tranconductance(note 3)	g _{FS}	V _{DS} =5V, I _D =10A		65		S
Diode forward voltage (note 3)	V _{SD}	I _S =1A, V _{GS} = 0V			1	V
DYNAMIC PARAMETERS (note 4)						
Input Capacitance	C _{iSS}	V _{DS} =10V,V _{GS} =0V,f =1MHz	1000		1510	pF
Output Capacitance	C _{oSS}		150		290	pF
Reverse Transfer Capacitance	C _{rSS}		100		235	pF
SWITCHING PARAMETERS (note 4)						
Turn-on delay time	t _{d(on)}	V _{GS} =4.5V,V _{DS} =10V, R _{GEN} =3Ω,R _L =1 Ω		1.1		ns
Turn-on rise time	t _r			2.6		ns
Turn-off delay time	t _{d(off)}			7		ns
Turn-off fall time	t _f			7.4		ns
Total Gate Charge	Q _g	V _{DS} =10V,V _{GS} =4.5V I _D =10A	10		15	nC
Gate-Source Chage	Q _{gs}			5.5		nC
Gage-Drain Charge	Q _{gd}			6.5		nC

Notes :

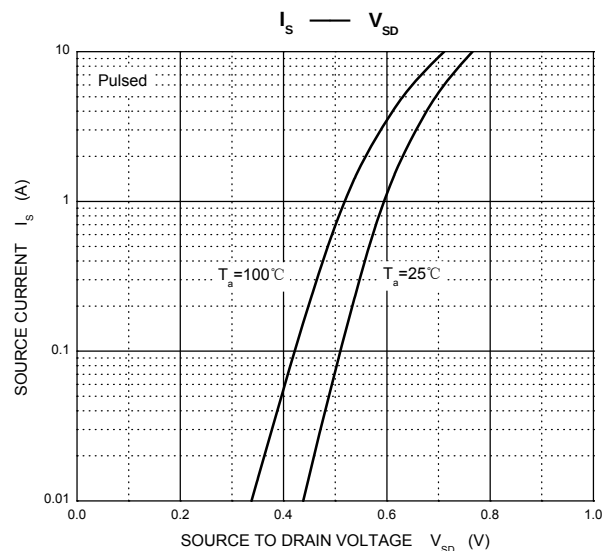
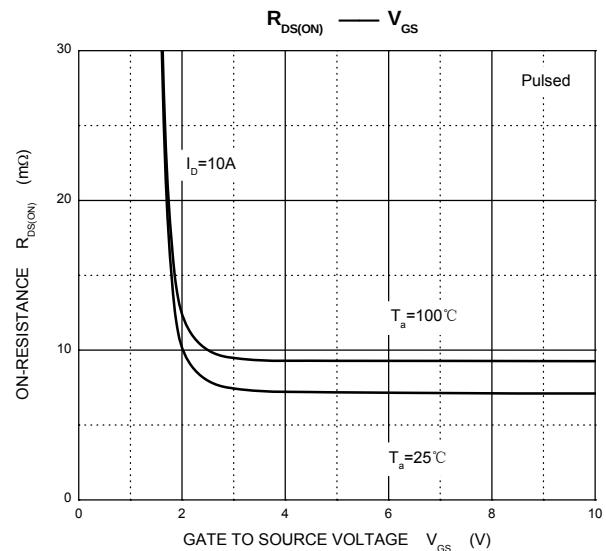
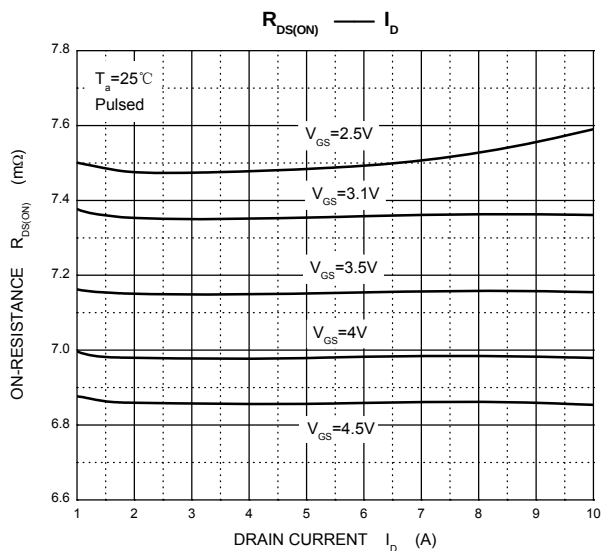
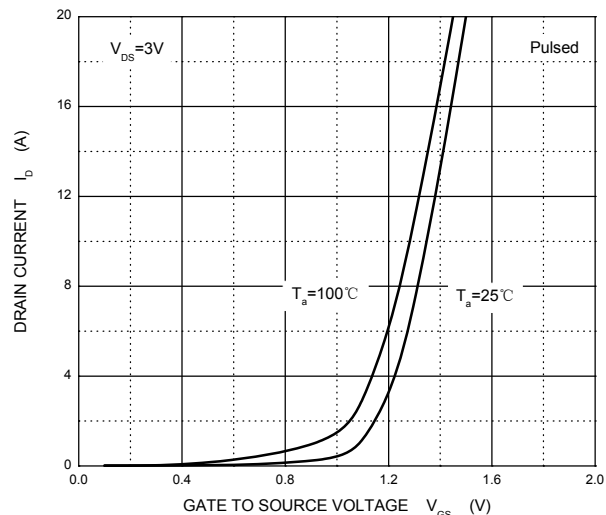
- 1.Repetitive rating: Pluse width limited by maximum junction temperature
- 2.Surface mounted on FR4 board, $t \leq 10$ sec.
3. Pulse Ttest : Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production.

Typical Characteristics

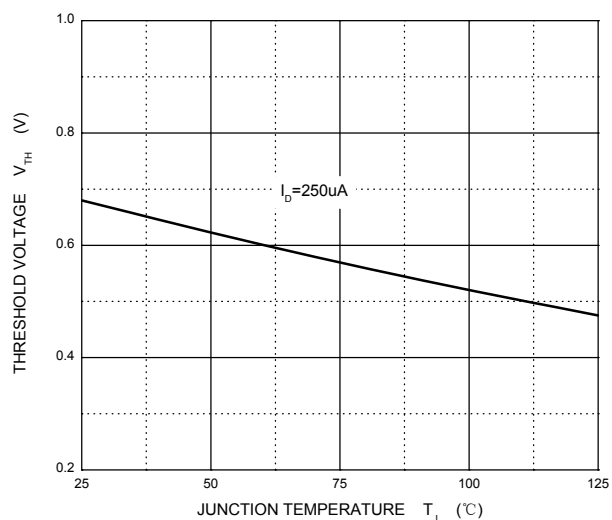
Output Characteristics



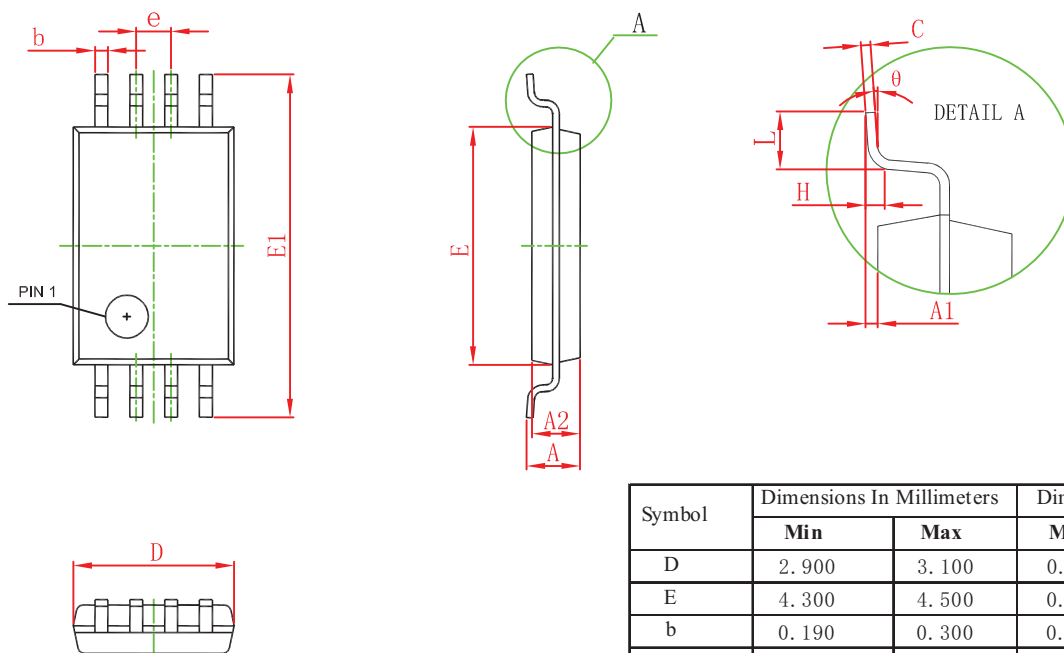
Transfer Characteristics



Threshold Voltage

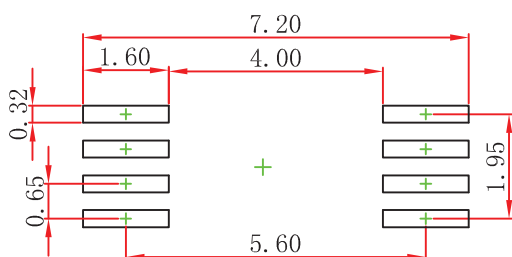


TSSOP8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.200		0.047
A2	0.800	1.000	0.031	0.039
A1	0.050	0.150	0.002	0.006
e	0.65 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

TSSOP8 Suggested Pad Layout



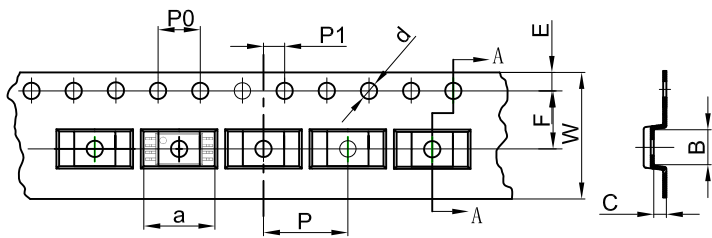
Note:
 1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.

NOTICE

JCET reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JCET does not assume any liability arising out of the application or use of any product described herein.

TSSOP8 Tape and Reel

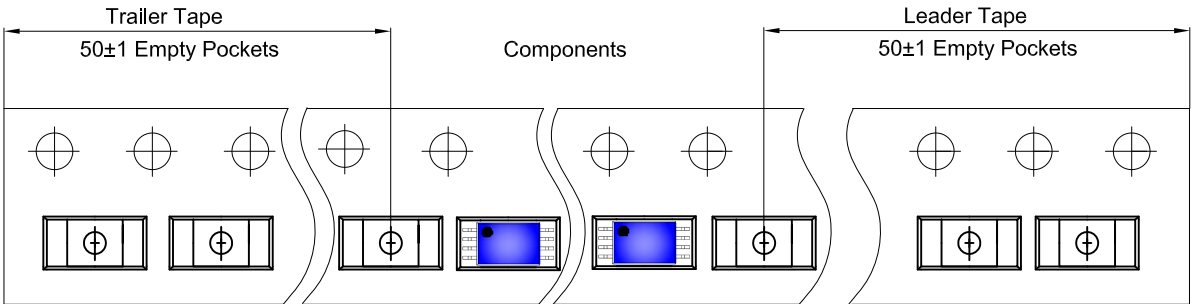
TSSOP8 Embossed Carrier Tape



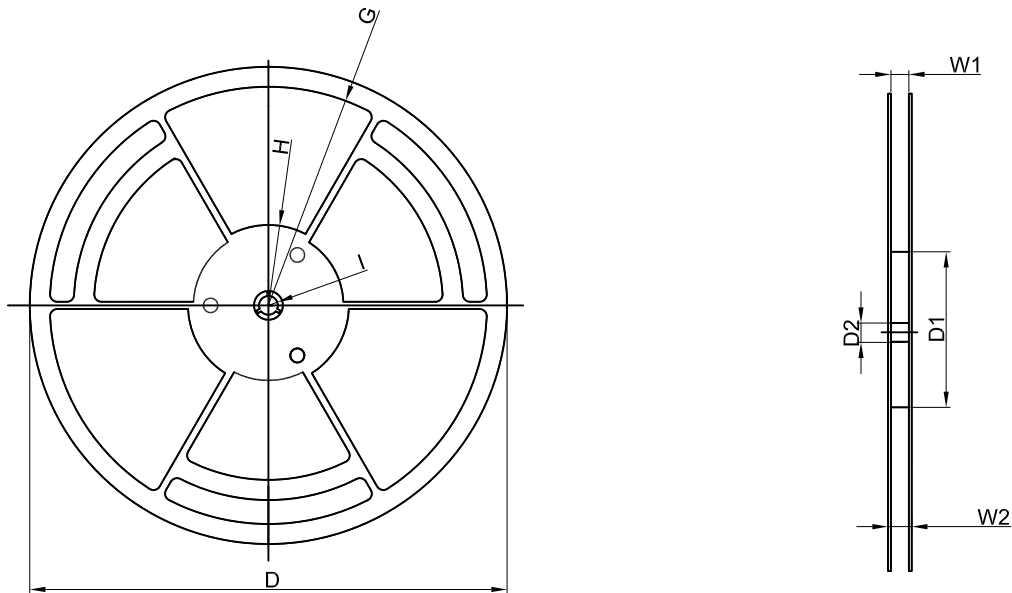
Packaging Description:
TSSOP8 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 13" or 33cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).
ALL DIM IN mm

Dimensions are in millimeter										
Pkg type	a	B	C	d	E	F	P0	P	P1	W
TSSOP8	6.76	3.30	1.20	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

TSSOP8 Tape Leader and Trailer



TSSOP8 Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
13"Dia	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3,000 pcs	13 inch	3,000 pcs	336×336×48	24,000 pcs	445×355×365	